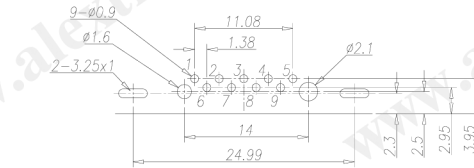
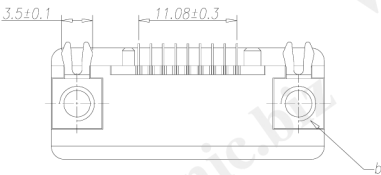
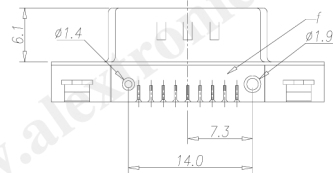
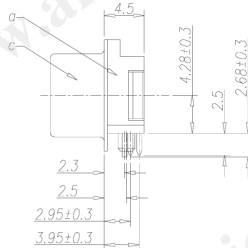
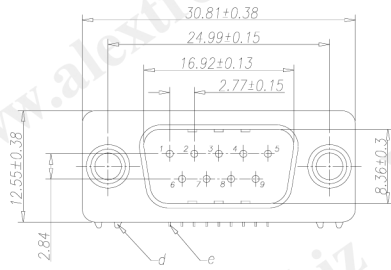


CATEGORY	DESCRIPTION	P/N #
CONNECTOR	D-SUB 9Pin Male, R/A, T/H	DB309M-11XX0-0501

REV.	ECN NO	DESCRIPTION	REVISED	DATE
R01		New Release	Luguan	2009.04.23

SPECIFICATIONS

- CONTACT CURRENT RATING:3 Amperes.
- DIELECTRIC WITHSTANDING VOLTAGE:AC 1000/60sec.r.m.s.
- INSULATION RESISTANCE:5000 Mohms MIN.AT DC 500V.
- CONTACT RESISTANCE:25 Milliohms MAX.
- TEMPERATURE: -55°C TO +105°C.
- GROUNDING SCREW TORQUE:3kg MIN.
- SOLDER HEAT RESISTANCE:WAVE SOLDERING 260° 10sec.
- TO CONFORM TO THE "SONY" DIRECTIVE.
- GREEN PRODUCT IDENTIFICATION LABEL IN PACKING: **G.P. PASS**
- ⊗ PRESENT CRITICAL DIMENSIONS.



Recommend PCB Layout
(Jack Top View)
Tolerance: ±0.05mm

PART NO:
DB309M-11XX0-0501

X	Shell Plating
1	Ni Plating
X	Terminal Plating
1	Gold Flash Plating

f	Cover	1	PBT UL94V-0	Green	
e	Terminal	9	Brass, T=0.2mm	Gold Flash Plating	
d	Board Lock	2	Brass, T=0.5mm	Tin Plating	
c	Shell	1	SPPC, T=0.35mm	Ni Plating	
b	Rivet	2	Brass	Ni Plating	
a	Housing	1	PBT UL94V-0	Green	
NO.	PART NAME	Q'TY	MATERIAL	PLATING & COLOR	Remark

UNLESS OTHERWISE SPECIFIED TOLERANCES

DECIMALS:	ANGLES:
X : ±0.5	X : ±2°
X.X : ±0.3	X.X : ±1'
X.XX : ±0.2	

Product Drawing			
ALEXTRONIC			
SCALE:1/1	UNIT: mm	⊕ ⊖	DWG.NO:
SIZE: A3	PAGE:1 OF 1	REV:R01	
APPROVED BY	CHECKED BY	PREPARED BY	
WYX	Pengjie	Luguan	
CUSTOMER COPY			